

STARPOWER

SEMICONDUCTOR

IGBT

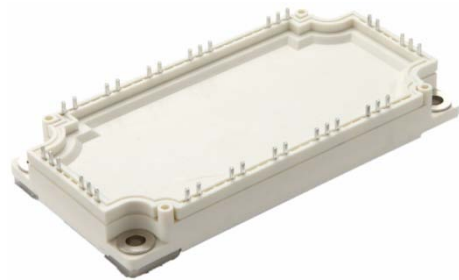
GD75PIT120C6SN_T4

Molding Type Module

1200V/75A PIM in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175 °C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

IGBT-inverter $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD75PIT120C6SN_T4	Units
V_{CES}	Collector-Emitter Voltage @ $T_j=25^\circ\text{C}$	1200	V
V_{GES}	Gate-Emitter Voltage @ $T_j=25^\circ\text{C}$	± 20	V
I_C	Collector Current @ $T_C=25^\circ\text{C}$ @ $T_C=100^\circ\text{C}$	110 75	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	150	A
P_{tot}	Total Power Dissipation @ $T_j=175^\circ\text{C}$	402	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1200			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V},$ $T_j=25^\circ\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V},$ $T_j=25^\circ\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=2.6\text{mA}, V_{CE}=V_{GE},$ $T_j=25^\circ\text{C}$	5.3	5.8	6.3	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=75\text{A}, V_{GE}=15\text{V},$ $T_j=25^\circ\text{C}$		1.85	2.30	V
		$I_C=75\text{A}, V_{GE}=15\text{V},$ $T_j=125^\circ\text{C}$		2.15		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=75A,$ $R_G=5.1\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		231		ns
t_r	Rise Time			57		ns
$t_{d(off)}$	Turn-Off Delay Time			268		ns
t_f	Fall Time			195		ns
E_{on}	Turn-On Switching Loss			4.95		mJ
E_{off}	Turn-Off Switching Loss			4.19		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=75A,$ $R_G=5.1\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$		240		ns
t_r	Rise Time			60		ns
$t_{d(off)}$	Turn-Off Delay Time			396		ns
t_f	Fall Time			343		ns
E_{on}	Turn-On Switching Loss			7.00		mJ
E_{off}	Turn-Off Switching Loss			6.90		mJ
C_{ies}	Input Capacitance	$V_{CE}=25V, f=1Mhz,$ $V_{GE}=0V$		4.30		nF
C_{res}	Reverse Transfer Capacitance			0.16		nF
Q_G	Gate Charge	$V_{CC}=600V, I_C=75A,$ $V_{GE}=-15 \dots +15V$		0.57		μC
R_{Gint}	Internal Gate Resistor			10		Ω
I_{SC}	SC Data	$t_p \leq 10\mu s, V_{GE}=15V,$ $T_j=125^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		270		A

Diode-inverter $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD75PIT120C6SN_T4	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ\text{C}$	1200	V
I_F	DC Forward Current	75	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1\text{ms}$	150	A

Characteristics Values

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=75\text{A}, V_{GE}=0\text{V}$	$T_j=25^\circ\text{C}$	1.70	2.10	V
			$T_j=125^\circ\text{C}$	1.65		
Q_r	Recovered Charge	$I_F=75\text{A}, V_R=600\text{V}, R_G=5.1\Omega, V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$	6.1		μC
			$T_j=125^\circ\text{C}$	11.2		
I_{RM}	Peak Reverse Recovery Current	$I_F=75\text{A}, V_R=600\text{V}, R_G=5.1\Omega, V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$	62		A
			$T_j=125^\circ\text{C}$	78		
E_{rec}	Reverse Recovery Energy	$I_F=75\text{A}, V_R=600\text{V}, R_G=5.1\Omega, V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$	2.89		mJ
			$T_j=125^\circ\text{C}$	5.24		

Diode-rectifier $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD75PIT120C6SN_T4	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ\text{C}$	1600	V
I_F	DC Forward Current @ $T_C=100^\circ\text{C}$	78	A
I_{RMSM}	Maximum RMS Current At Rectifier Output @ $T_C=80^\circ\text{C}$	140	A
I_{FSM}	Surge Forward Current $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^\circ\text{C}$	1100	A
I^2t	I^2t -value, $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^\circ\text{C}$	6050	A^2s

Characteristics Values

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=75\text{A}, T_j=150^\circ\text{C}$		1.08		V
I_R	Reverse Current	$T_j=150^\circ\text{C}, V_R=1600\text{V}$			2.0	mA

IGBT-brake-chopper $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD75PIT120C6SN_T4	Units
V_{CES}	Collector-Emitter Voltage @ $T_j=25^\circ\text{C}$	1200	V
V_{GES}	Gate-Emitter Voltage @ $T_j=25^\circ\text{C}$	± 30	V
I_C	Collector Current @ $T_C=25^\circ\text{C}$	70	A
	@ $T_C=100^\circ\text{C}$	35	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	70	A
P_{tot}	Total Power Dissipation @ $T_j=175^\circ\text{C}$	288	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1200			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=1.7\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.0	6.1	7.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=35\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.90	2.35	V
		$I_C=35\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.30		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=35A,$ $R_G=24\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		291		ns
t_r	Rise Time			66		ns
$t_{d(off)}$	Turn-Off Delay Time			248		ns
t_f	Fall Time			205		ns
E_{on}	Turn-On Switching Loss			4.29		mJ
E_{off}	Turn-Off Switching Loss			1.64		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=35A,$ $R_G=24\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$		295		ns
t_r	Rise Time			69		ns
$t_{d(off)}$	Turn-Off Delay Time			260		ns
t_f	Fall Time			242		ns
E_{on}	Turn-On Switching Loss			4.76		mJ
E_{off}	Turn-Off Switching Loss			2.57		mJ
C_{ies}	Input Capacitance	$V_{CE}=30V, f=1Mhz,$ $V_{GE}=0V$		4.12		nF
C_{res}	Reverse Transfer Capacitance			0.10		nF
Q_G	Gate Charge	$V_{CC}=600V, I_C=35A,$ $V_{GE}=15V$		170		nC
R_{Gint}	Internal Gate Resistor			/		Ω
I_{SC}	SC Data	$t_p \leq 10\mu s, V_{GE}=15V,$ $T_j=125^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		350		A

Diode-brake-chopper $T_C=25^\circ C$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD75PIT120C6SN_T4	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ C$	1200	V
I_F	DC Forward Current	35	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1ms$	70	A

Characteristics Values

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
V_F	Diode Forward Vd tage	$I_F=35A, V_{GE}=0V$	$T_j=25^\circ C$		2.00	2.40	V
			$T_j=125^\circ C$		1.90		
Q_r	Recovered Charge	$I_F=35A,$ $V_R=600V,$ $R_G=24\Omega,$ $V_{GE}=-15V$	$T_j=25^\circ C$		2.2		μC
			$T_j=125^\circ C$		4.2		
I_{RM}	Peak Reverse Recovery Current	$V_{GE}=-15V$	$T_j=25^\circ C$		19		A
			$T_j=125^\circ C$		23		
E_{rec}	Reverse Recovery Energy	$V_{GE}=-15V$	$T_j=25^\circ C$		1.20		mJ
			$T_j=125^\circ C$		2.23		

Electrical Characteristics of NTC $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
R_{25}	Rated Resistance			5.0		$\text{k}\Omega$
$\Delta R/R$	Deviation of R_{100}	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K

IGBT Module

Symbol	Parameter	Min.	Typ.	Max.	Units
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}, t=1\text{min}$	4000			V
L_{CE}	Stray Inductance		40		nH
$R_{\theta\text{JC}}$	Junction-to-Case (per IGBT-inverter)			0.373	K/W
	Junction-to-Case (per Diode-inverter)			0.590	
	Junction-to-Case (per Diode-rectifier)			0.560	
	Junction-to-Case (per IGBT-brake-chopper)			0.521	
	Junction-to-Case (per Diode-brake-chopper)			1.024	
$R_{\theta\text{CS}}$	Case-to-Sink (per IGBT-inverter)		0.134		K/W
	Case-to-Sink (per Diode-inverter)		0.212		
	Case-to-Sink (per Diode-rectifier)		0.201		
	Case-to-Sink (per IGBT-brake-chopper)		0.187		
	Case-to-Sink (per Diode-brake-chopper)		0.367		
$R_{\theta\text{CS}}$	Case-to-Sink (Conductive grease applied)		0.009		K/W
T_{jmax}	Maximum Junction Temperature (inverter,brake)			175	$^{\circ}\text{C}$
	Maximum Junction Temperature(rectifier)			150	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature	-40		150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40		125	$^{\circ}\text{C}$
M	Mounting Torque, Screw:M5	3.0		6.0	N.m
G	Weight of Module		300		g

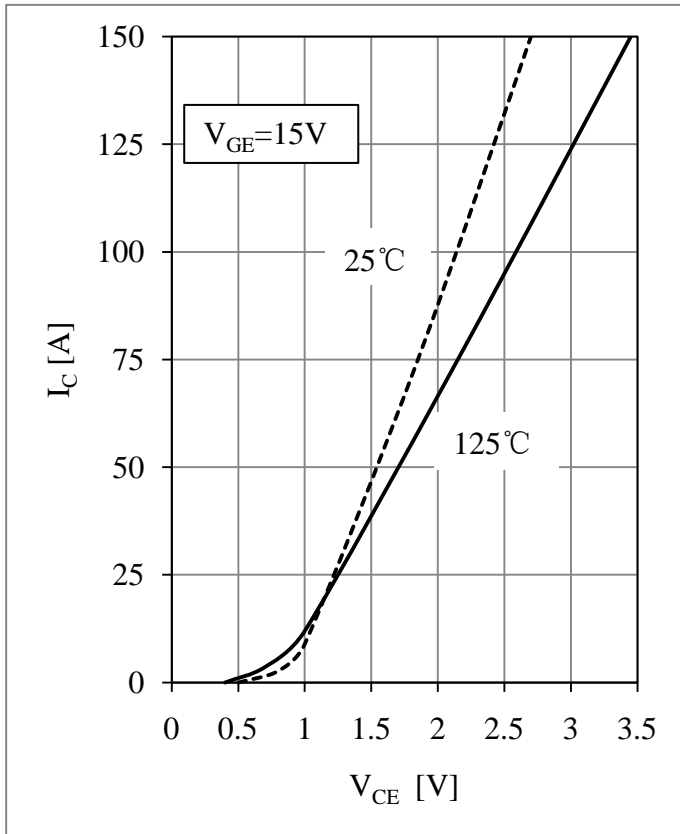


Fig 1. IGBT-inverter Output Characteristics

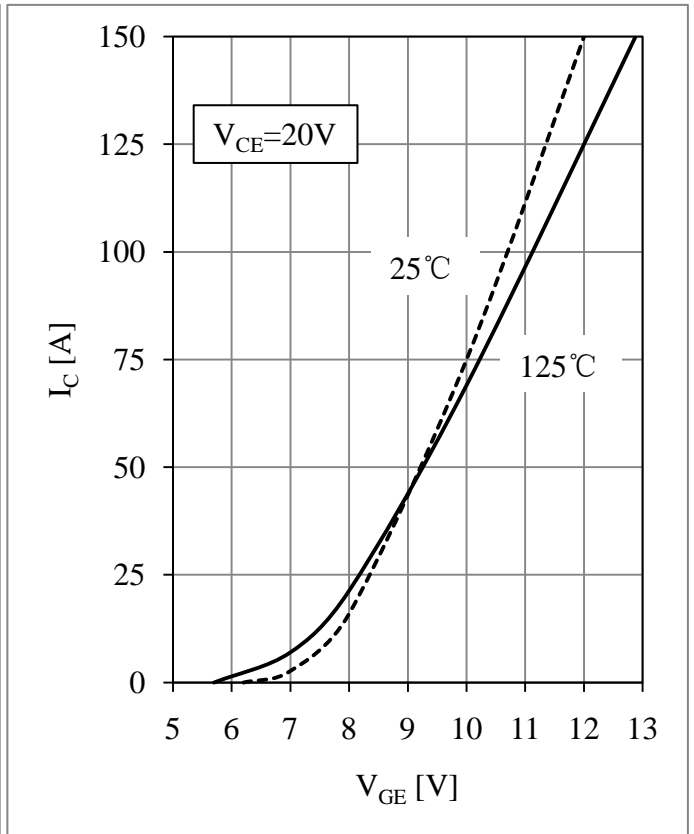


Fig 2. IGBT-inverter Transfer Characteristics

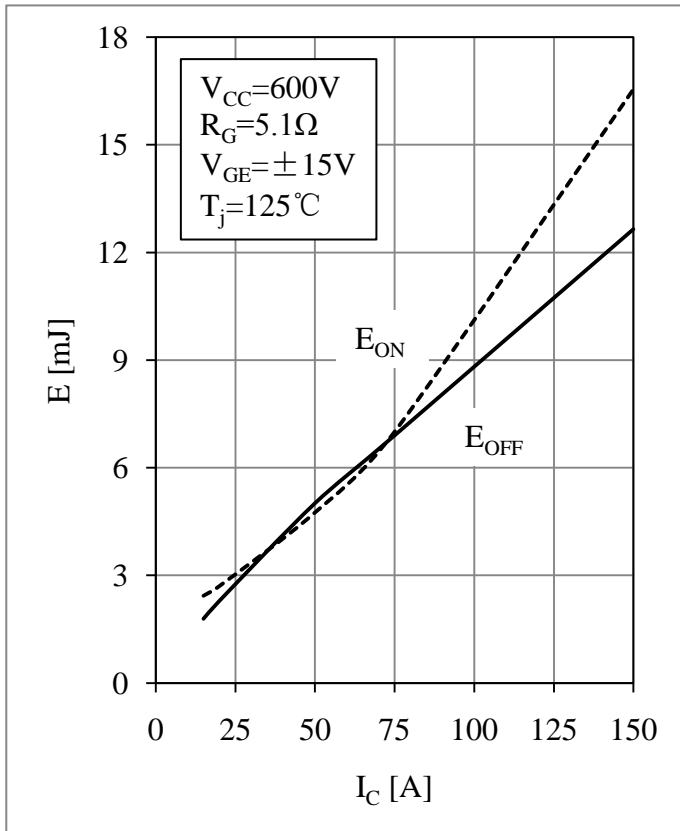


Fig 3. IGBT-inverter Switching Loss vs. I_C

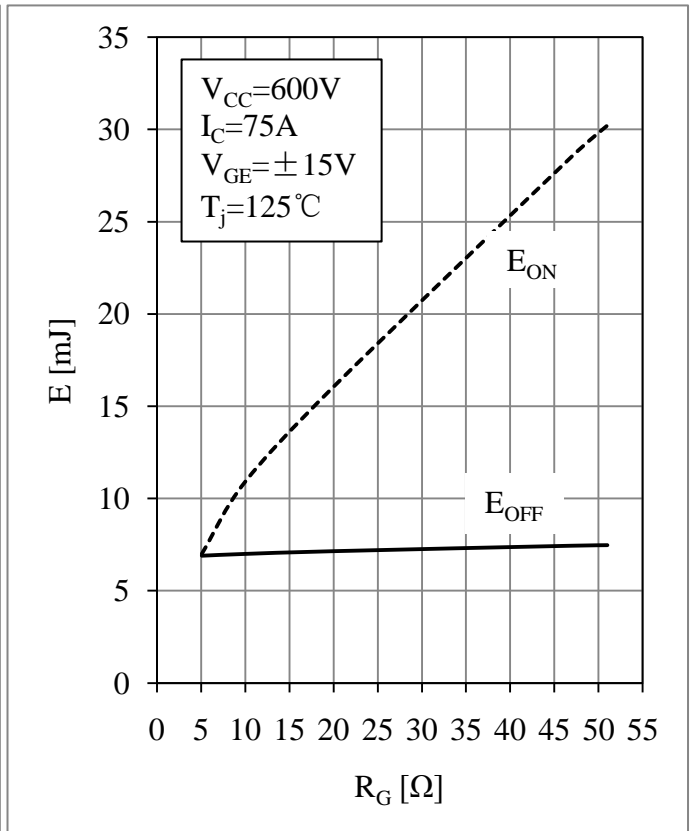


Fig 4. IGBT-inverter Switching Loss vs. R_G

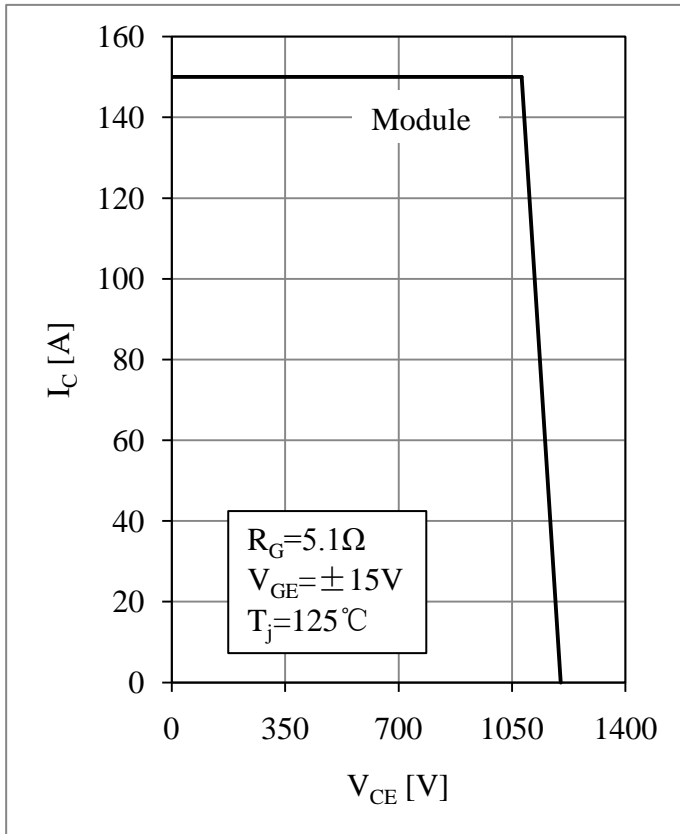


Fig 5. IGBT-inverter RBSOA

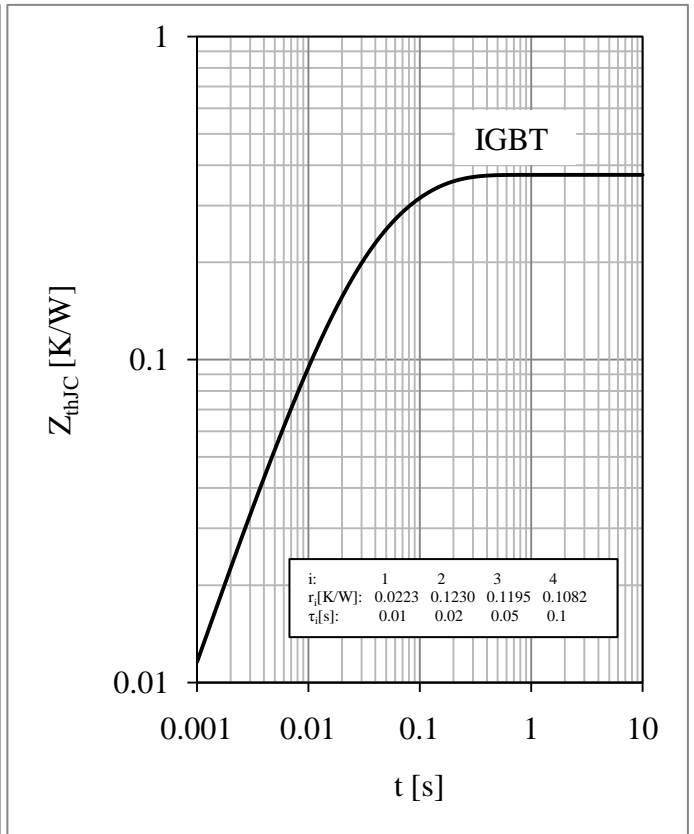


Fig 6. IGBT-inverter Transient Thermal Impedance

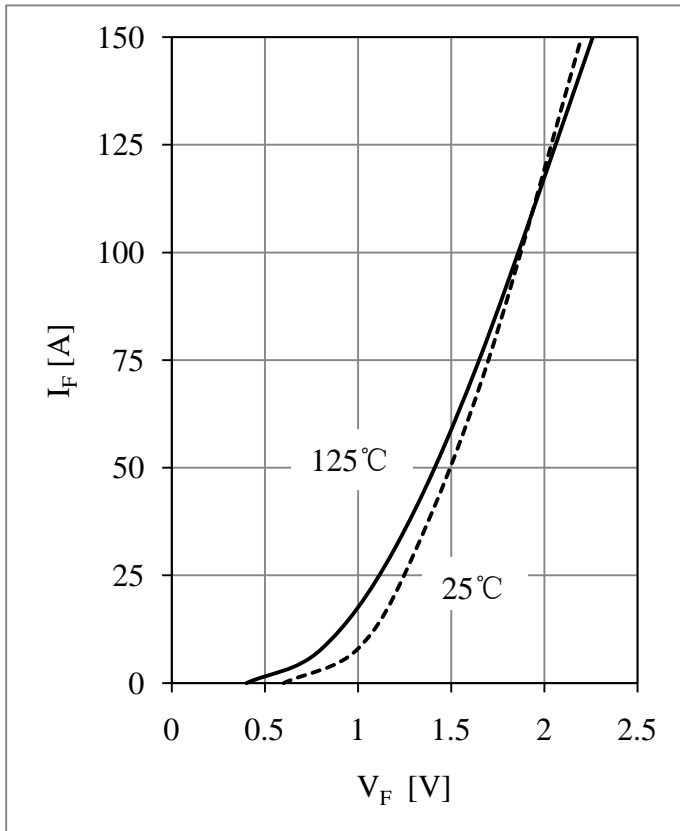


Fig 7. Diode-inverter Forward Characteristics

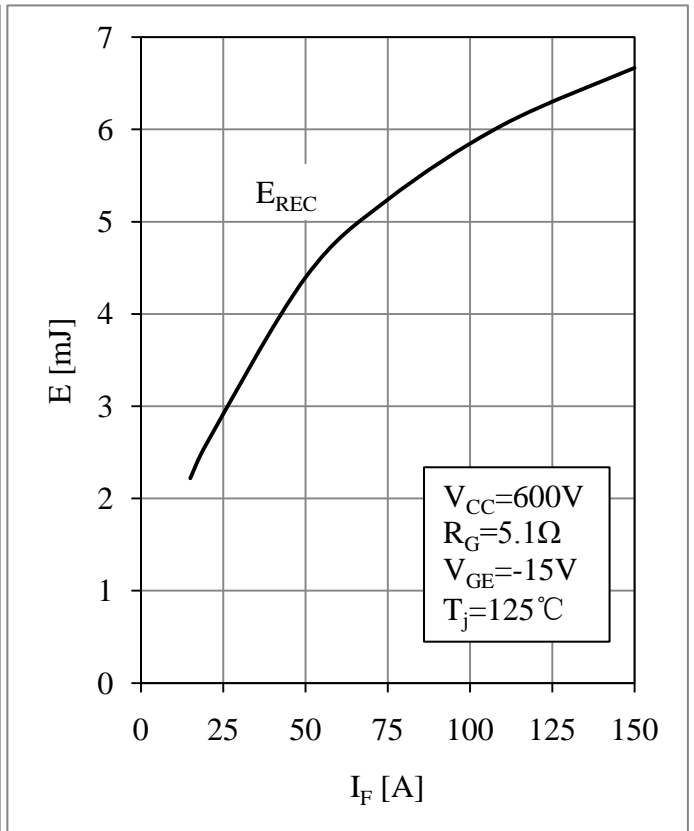


Fig 8. Diode-inverter Switching Loss vs. I_F

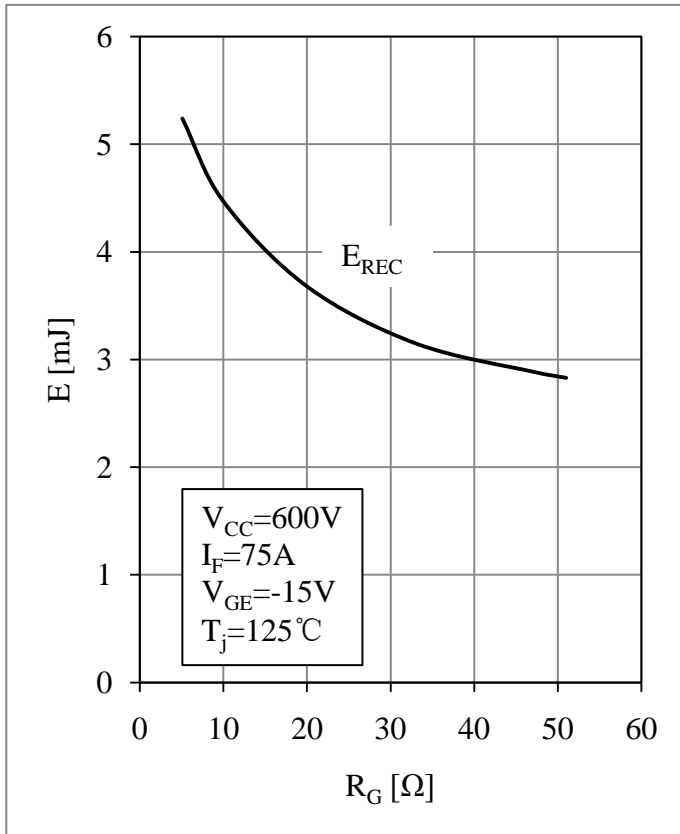


Fig 9. Diode-inverter Switching Loss vs. R_G

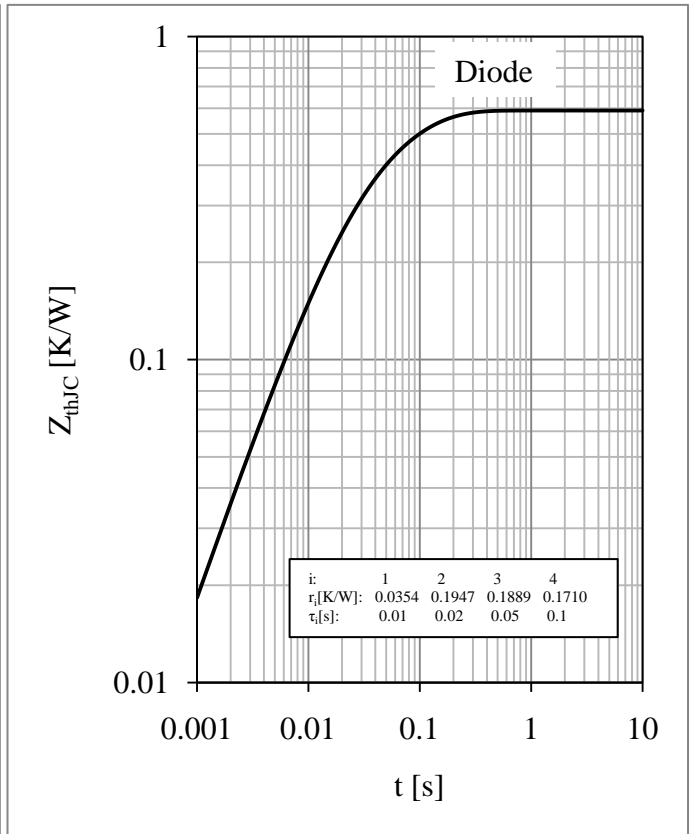


Fig 10. Diode-inverter Transient Thermal Impedance

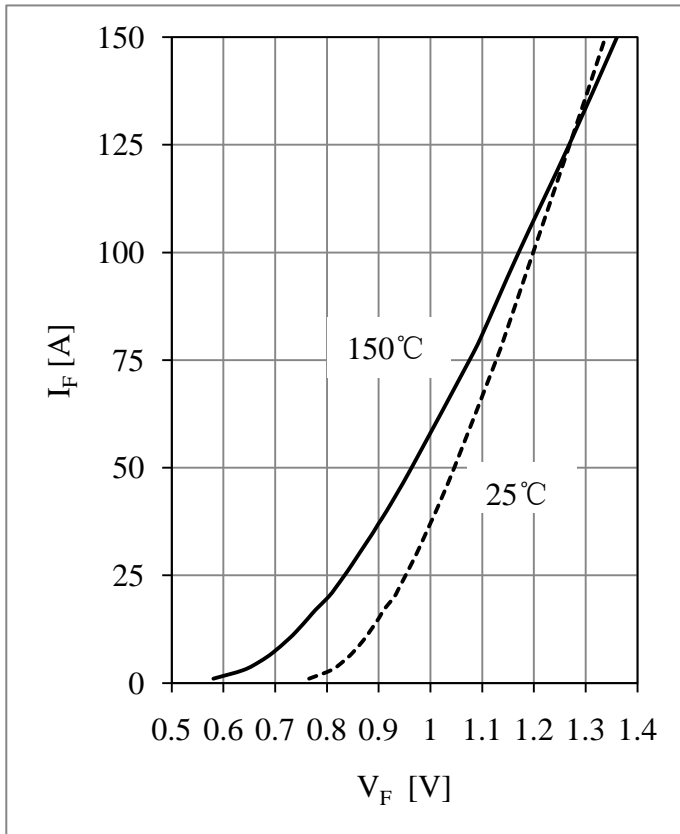


Fig 11. Diode-rectifier Forward Characteristics

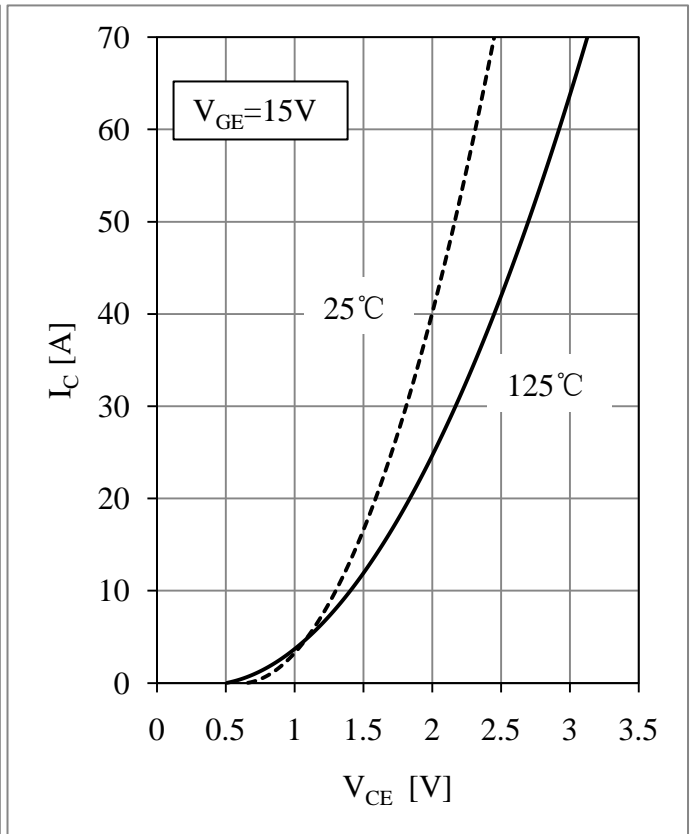


Fig 12. IGBT-brake-chopper Output Characteristics

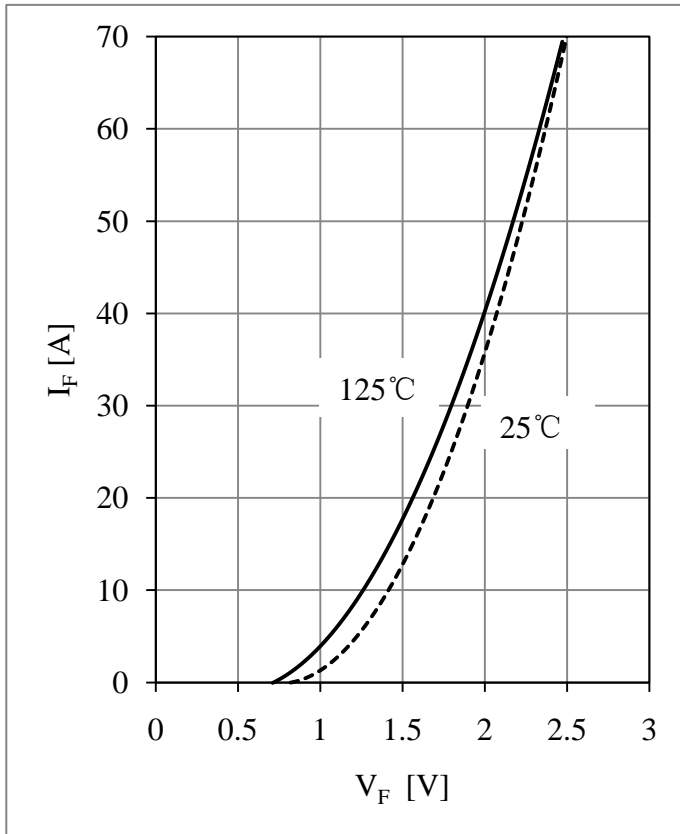


Fig 13. Diode-brake-chopper Forward Characteristics

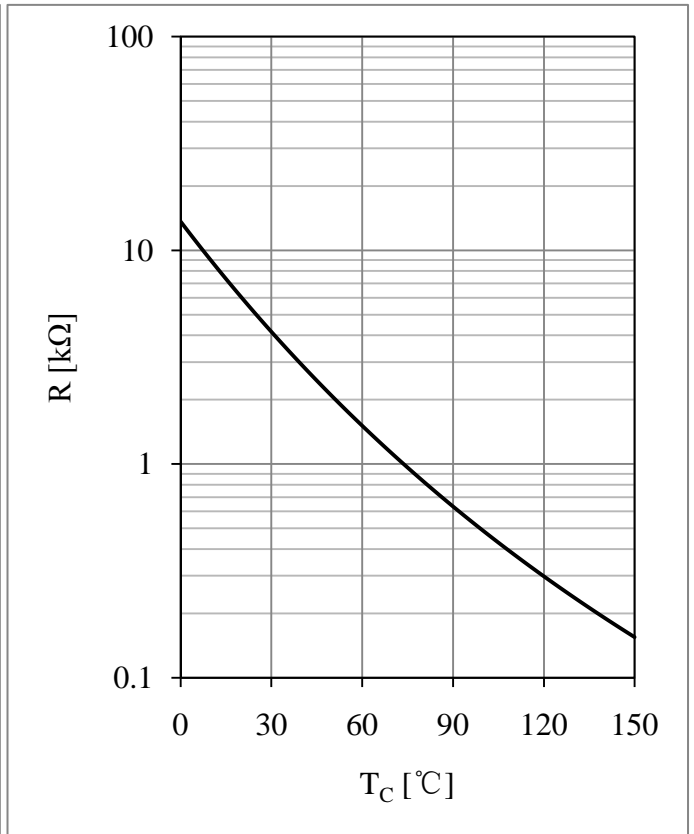
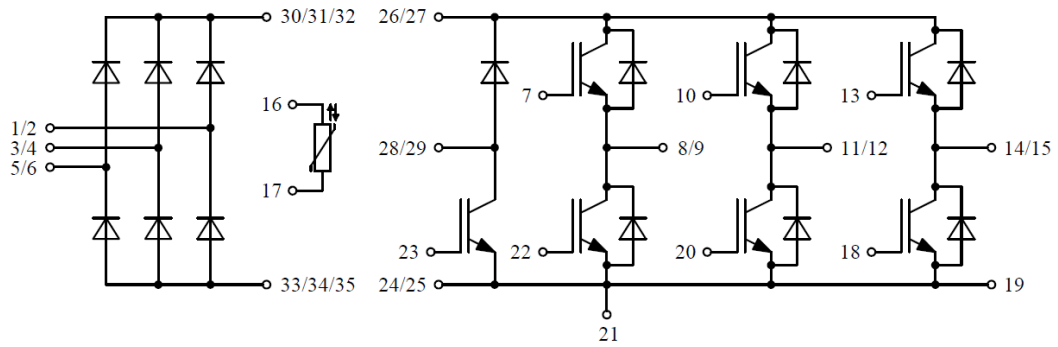


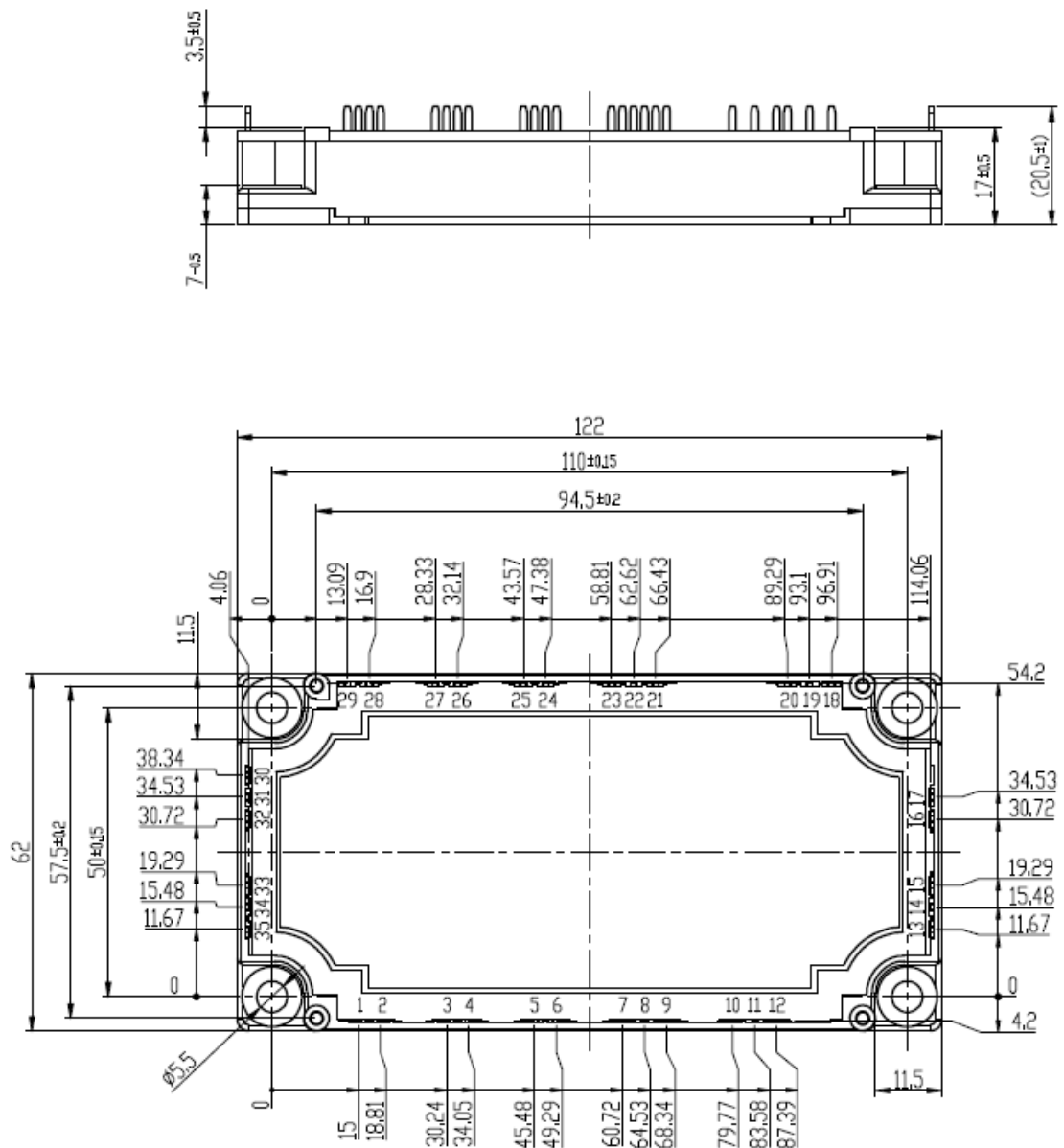
Fig 14. NTC Temperature Characteristic

Equivalent Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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This product data sheet is describing the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its characteristics.

Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of our product, please contact the sales office, which is responsible for you (see www.powersemi.cc), For those that are specifically interested we may provide application notes.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify.

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